

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Daisuke OKAMURA et al.

Serial No. (unknown)

Filed herewith

METHOD OF RECYCLING MOLD PLASTIC
PARTS FOR PHOTSENSITIVE MATERIAL
AND A RECYCLED PLASTIC MOLD PARTS

PRELIMINARY AMENDMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

Prior to the first Official Action and calculation of the filing fee, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please add the following paragraph between lines 16 and 17 in page 86:

--Table 4 of Fig. 7 illustrates estimations of physical properties. The physical properties of recycled

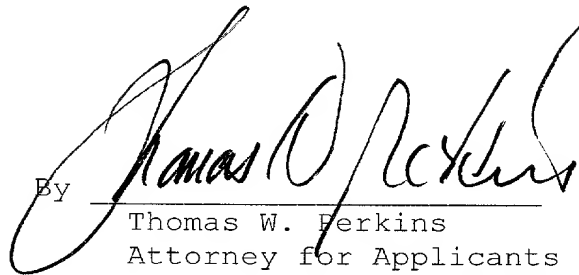
Daisuke OKAMURA et al.

film units 2-5 are compared with that of a sample film unit
1.--

Respectfully submitted,

YOUNG & THOMPSON

By



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